

### Features

- ultra-low On Resistance: 1.5  $\Omega$
- Supply voltage: 1.5 ~ 5.5V
- -3dB Bandwidth: 700MHz
- Rail-to-Rail Signal Range
- Break-Before-Make Switching
- Low quiescent current over an Expanded Control Input Range

### Applications

- Audio and Video Signal Routing
- Other electronics equipment
- LCD Monitor, TV and Set-Top Box
- Cell phones, PDA, Digital Camera and Notebook

### General Description

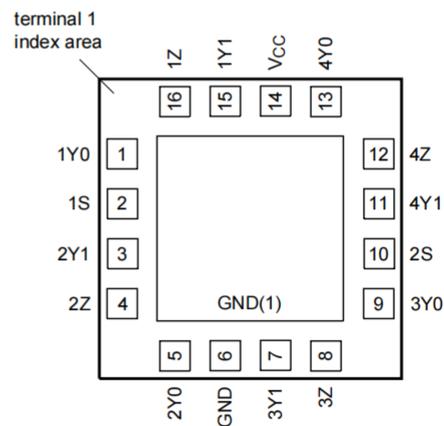
The is a high performance, quad, Single Pole Double Throw (SPDT) analog switch that features ultra-low Ron of 0.5  $\Omega$  (typical) at 3.0V VCC. The operates over a wide VCC range of 2.3V to 4.5V and is designed for break-before-make operation. The select input is TTL-level compatible.

The is also featured with smart circuitry to minimize VCC leakage current even when the control voltage is lower than VCC supply voltage. This feature suits mobile handset applications by allowing direct interface with baseband processor general-purpose IO with minimal battery consumption. In other word, there is no need of additional device to shift control level to be the same as that of VCC in real application.

The is available in QFN 3x3-16L package. Standard Products are Pb-free and halogen-free.

### PIN CONFIGURATIONS

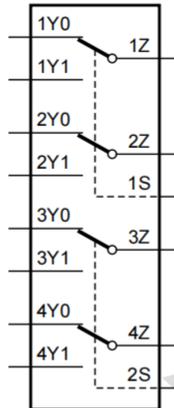
(TOP VIEW)  
QFN3X3-16L



### PIN DESCRIPTION

Symbol	Pin	Description
1Y0, 2Y0, 3Y0, 4Y0	1, 5, 9, 13	independent input or output
1S, 2S	2, 10	select input
1Y1, 2Y1, 3Y1, 4Y1	15, 3, 7, 11	independent input or output
1Z, 2Z, 3Z, 4Z	16, 4, 8, 12	common output or input
GND	6	ground (0 V)
V <sub>CC</sub>	14	supply voltage

### Functional diagram



### Function Table

Input nS	Channel on
L	nY0
H	nY1

### Absolute Maximum Ratings

(Unless otherwise specified)

Parameter	Symbol	Value	Unit
Supply Voltage	$V_{CC}$	-0.3 ~ 6.5	V
Control Input Voltage	$V_{IN}$	-0.3 ~ 6.5	V
DC Input Voltage	$V_{INPUT}$	-0.3 ~ 6.5	V
Continuous Current		±100	mA
Peak Current (pulsed at 1ms 50% duty cycle)		±200	mA
Peak Current (pulsed at 1ms 10% duty cycle)		±200	mA
Storage Temperature Range	$T_{STG}$	-65 ~ 150	°C
Junction Temperature under Bias	$T_J$	150	°C
Lead Temperature (Soldering, 10 seconds)	$T_L$	260	°C
Power Dissipation	$P_D$	250	mW

Note: Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied.

### Recommend operating ratings

(Unless otherwise specified)

Parameter	Symbol	Value	Unit
Supply Voltage Operating	$V_{CC}$	1.5 ~ 5.5	V
Control Input Voltage	$V_{IN}$	0.0 ~ $V_{CC}$	V
Input Signal Voltage	$V_{IS}$	0.0 ~ $V_{CC}$	V
Operating Temperature	$T_A$	-40 ~ 85	°C
Input Raise and Fall Time(Control Input $V_{CC}=2.3\sim 3.6V$ )	$t_r, t_f$	0 ~ 10	ns/V
Thermal Resistance	$R_{\theta JA}$	350	°C/W

Note:Control input must be held high or Low, it must not float.

### DC Electrical Characteristics

(TA =25°C, VC=+4.5V, unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Input logic high level	V <sub>IH</sub>	VCC: 3.0 ~ 4.5	1.6	--	--	V
		VCC: 2.3 ~ 3.0	1.4	--	--	V
Input logic low level	V <sub>IL</sub>	VCC: 3.0 ~ 4.5	--	--	0.6	V
		VCC: 2.3 ~ 3.0	--	--	0.4	V
Supply quiescent current	I <sub>CC</sub>	I <sub>OUT</sub> =0, V <sub>IN</sub> =0 or V <sub>IN</sub> =VCC	--	--	1.0	uA
Increase in I <sub>CC</sub> per input	I <sub>CC</sub> T	I <sub>OUT</sub> =0, VCC=4.5 V <sub>IN</sub> >1.8 or V <sub>IN</sub> <0.5	--	--	2.0	uA
Input leakage current	I <sub>IN</sub>	V <sub>SEL</sub> =VCC	--	--	±1.0	uA
Off state switch leakage current	I <sub>OFF</sub>		--	--	±1.0	uA
On state switch leakage current	I <sub>ON</sub>		--	--	±1.0	uA
On-Resistance	R <sub>ON</sub>	VCC=4.5V, V <sub>IS</sub> =0~4.5V, I <sub>ON</sub> =100mA,	--	1.5	--	Ω
		VCC=3.0V, V <sub>IS</sub> =0~3.0V, I <sub>OUT</sub> =100mA,	--	1.8	--	Ω
On-Resistance Matching Between Channels	Δ R <sub>ON</sub>	VCC=4.5V, V <sub>IS</sub> =0.8V, I <sub>OUT</sub> =100mA,	--	0.1	--	Ω
		VCC=3.0V, V <sub>IS</sub> =0.8V, I <sub>OUT</sub> =100mA,	--	0.14	--	Ω
On-Resistance Flatness	R <sub>FLAT(ON)</sub>	VCC=4.5V, V <sub>IS</sub> =0~4.5V, I <sub>OUT</sub> =100mA,	--	--	0.5	Ω
		VCC=3.0V, V <sub>IS</sub> =0~3.0V, I <sub>OUT</sub> =100mA,	--	--	0.8	Ω

### AC Electronics Characteristics

(Ta=25°C, VCC=+4.5V, unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Turn-On Time	T <sub>ON</sub>	VCC=4.5V, V <sub>IS</sub> =1.5V, C <sub>L</sub> =35pF, R <sub>L</sub> =50Ω	--	200	--	ns
Turn-Off Time	T <sub>OFF</sub>	VCC=4.5V, V <sub>IS</sub> =1.5V, C <sub>L</sub> =35pF, R <sub>L</sub> =50Ω	--	200	--	ns
Break-Before-Make time	T <sub>BBM</sub>	Generate by design	--	100	--	ns
-3dB Bandwidth	BW	R <sub>L</sub> =50Ω, C <sub>L</sub> =0pF	--	700	--	MHz
Off isolation (Per Channel)	OIRR	F=100KHz, R <sub>L</sub> =50Ω	--	-50	--	dB
Crosstalk (Channel to Channel)	Xtalk	F=100KHz, R <sub>L</sub> =50Ω	--	-50	--	dB
Total Harmonic Distortion	THD	F=20Hz to 20KHz R <sub>L</sub> =32Ω, V <sub>IS</sub> =0.5Vp-p	--	-80	--	dB

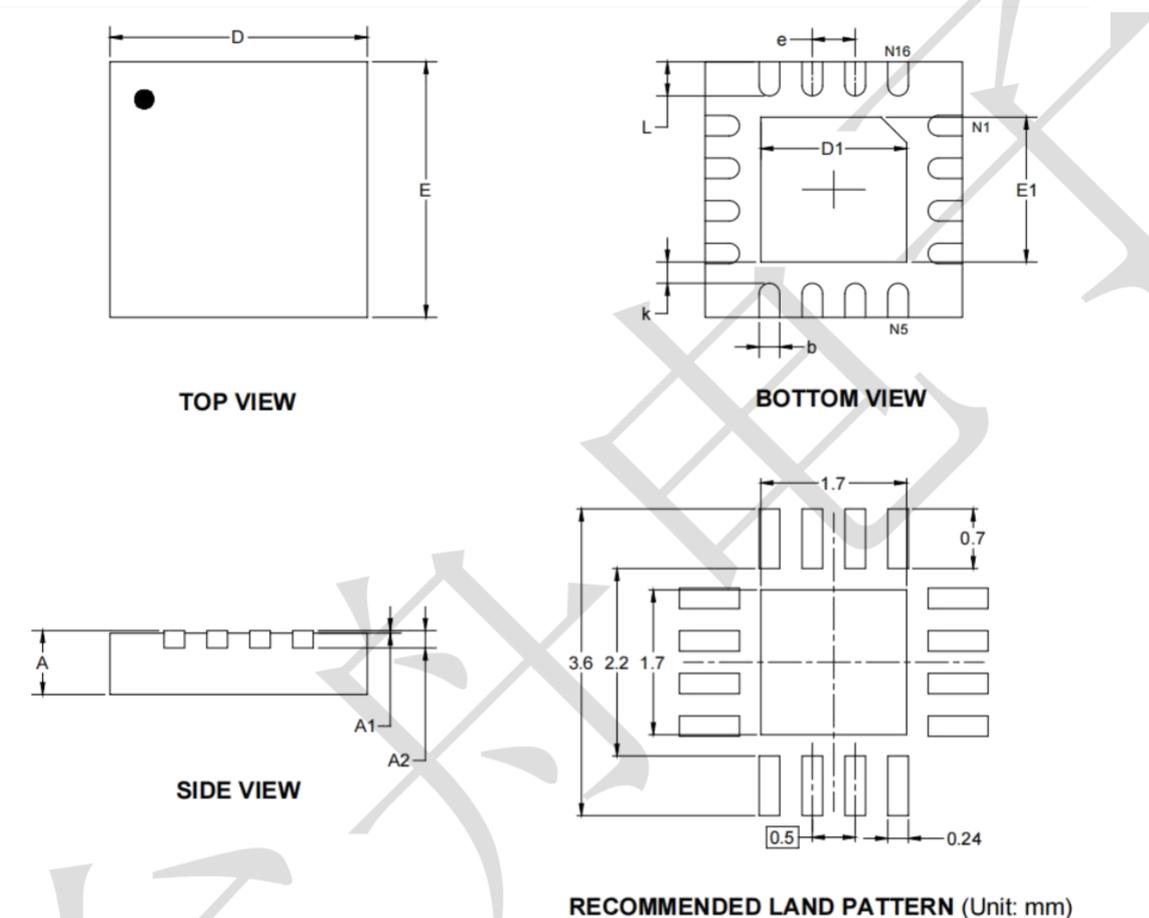
### Capacitance

(Ta=25°C, unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Off capacitance	C <sub>OFF</sub>	F=1MHz, VCC=3.3V	--	5	--	pF
On capacitance	C <sub>ON</sub>	F=1MHz, VCC=3.3V	--	8	--	pF

### Package information

QFN3X3-16L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A2	0.203 REF		0.008 REF	
D	2.900	3.100	0.114	0.122
D1	1.600	1.800	0.063	0.071
E	2.900	3.100	0.114	0.122
E1	1.600	1.800	0.063	0.071
k	0.200 MIN		0.008 MIN	
b	0.180	0.300	0.007	0.012
e	0.500 TYP		0.020 TYP	
L	0.300	0.500	0.012	0.020